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U.S. DEPARTMENT OF COMMERCE
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Tab settings

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Yoshitsugu Morita , Hiroshi Ueki,
Haruhiko Furukawa, Koji Nakanishi

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: 7/6/04, 7/7/04

2. Name and address of receiving party(ies)

Name: Dow Corning Toray Silicone Co. LTD

Internal Address: 4th Floor, AIG Building

Street Address: 1-1-3, Marunouchi, 1-chome
Chiyoda-ku

City: Tokyo State: JP Zip: 100-005

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 8/11/04

A. Patent Application No.(s) _____

B. Patent No.(s) _____

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Robert L. McKellar

Internal Address: Poseyville Professional
Complex

Street Address: 784 South Poseyville Road

City: Midland State: MI Zip: 48640

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number:

13-2492

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9. Signature.

Robert L. McKellar
Name of Person Signing

Robert L. McKellar
Signature

8/11/04
Date

Total number of pages including cover sheet, attachments, and documents: 5

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

ASSIGNMENT

WHEREAS We, Yoshitsugu Morita, Hiroshi Ueki, Haruhiko Furukawa and Koji Nakanishi have invented certain new and useful improvements in

SILICONE RESIN COMPOSITION, CURABLE RESIN COMPOSITION, AND CURED RESIN

for which application for United States Letters Patent has been executed by us on this 6th day of July, 2004; and, 7th day of July, 2004.

WHEREAS, DOW CORNING TORAY SILICONE COMPANY, LTD., 4th Floor, AIG Building, 1-3, Marunouchi 1-chome, Chiyoda-ku, Tokyo 100-0005, JAPAN, is desirous of acquiring the said invention and said application and any and all Letters Patent that may be obtained therefor or thereupon, and all reissues and extensions thereof;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of 100 Yen, and other good and valuable considerations, to us in hand paid by the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, the receipt of which is hereby acknowledged, we have sold, assigned, transferred and set over and by these presents do sell, assign, transfer and set over unto the said DOW CORNING TORAY SILICONE COMPANY, LTD., its successors, and assigns, the full and exclusive right, title and interest in and to said invention and said application for Letters Patent of the United States therefor, and in and to any Divisions and Continuations thereof and in and to any and all United States Letters Patent and reissues and extensions thereof that may be issued for the said invention, to have and to hold for its own use and behoof and the use and behoof of its successors and assigns as fully and entirely as the same might be enjoyed by us if this sale and assignment had not been made; and

HEREBY AUTHORIZE and request the Commissioner of Patents and Trademarks to issue the said Letters Patent and any reissues and extensions thereof to the said DOW CORNING TORAY SILICONE COMPANY, LTD. as assigns of the entire right, title and interest in and to the said invention and said application and Letters Patent issued therefor or thereupon; and

HEREBY AGREE to execute all instruments and documents within our power which may be necessary for the carrying out of this assignment in full; and to execute any divisional or continuing application or applications which may be necessary or proper to obtain full protection on the invention hereby assigned; and to execute any and all supplemental oaths and preliminary statements should the same be proper and necessary in the prosecution of the aforesaid applications; and

HEREBY FURTHER ASSIGN unto the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors, and assigns, the whole right, title and interest in and to the invention disclosed in the said application throughout all countries foreign to the United States, and do hereby ratify any acts of the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns, in applying for patents therefor in its own name in countries where such procedure is proper and do agree to execute applications for said invention in the several countries where it is necessary that the same be executed by the inventors, and to execute assignments of such applications and the patents to be obtained therefor to the said DOW CORNING TORAY SILICONE CO., LTD., its successors and assigns.

IN WITNESS WHEREOF I have hereunto set my hand

Yoshitsugu Morita

Yoshitsugu Morita

July 6, 2004

Date

This is to certify that Yoshitsugu Morita has signed this document in my presence this 6th day of July, 2004, Japan.

Hiromi Fujita

Signature of Witness

Hiromi Fujita

IN WITNESS WHEREOF I have hereunto set my hand

Hiroshi Ueki

Hiroshi Ueki

July 6, 2004

Date

This is to certify that Hiroshi Ueki has signed this document in my presence this 6th day of July, 2004, Japan.

Hiromi Fujita

Signature of Witness

Hiromi Fujita

IN WITNESS WHEREOF I have hereunto set my hand

Haruhiko Furukawa

Haruhiko Furukawa

July 6, 2004

Date

This is to certify that Haruhiko Furukawa has signed this document in my presence this 6th day of July, 2004, Japan.

Hiromi Fujita

Signature of Witness

Hiromi Fujita

IN WITNESS WHEREOF I have hereunto set my hand

Koji Nakanishi
Koji Nakanishi

July, 7, 2004
Date

This is to certify that Koji Nakanishi has signed this document in my presence this 7th day of
July, 2004, Japan.

Hiromi Fujita
Signature of Witness
Hiromi Fujita